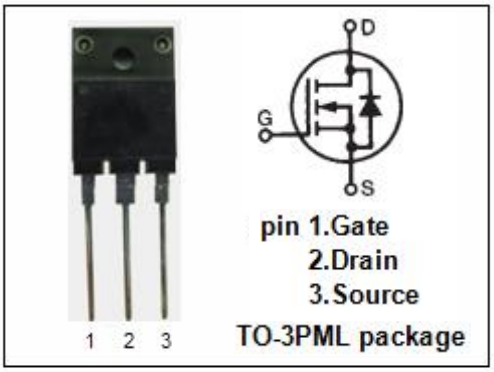
isc N-Channel MOSFET Transistor 3N150S

- **FEATURES**
- Drain Current I_D= 2.5A@ T_C=25℃
- Drain Source Voltage-
  : V_{DSS}= 1500V(Min)
- Static Drain-Source On-Resistance
  : $R_{DS(on)}$ = 9Ω (Max)
- Fast Switching
- Minimum Lot-to-Lot variations for robust device performance and reliable operation



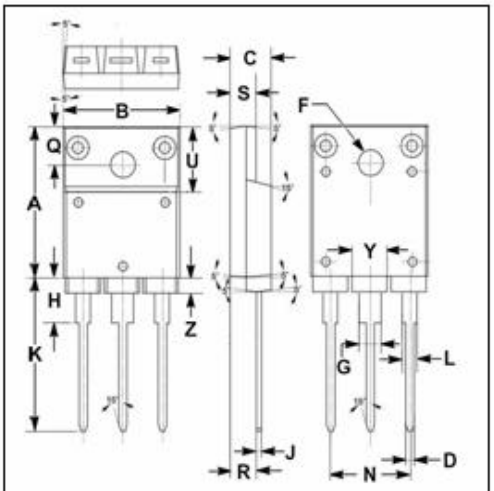
- **APPLICATIONS**
- Switching power supplies,converters,AC and DC motor controls

- **ABSOLUTE MAXIMUM RATINGS(T_a=25℃)**

SYMBOL	PARAMETER	VALUE	UNIT
V_{DSS}	Drain-Source Voltage	1500	V
V_{GS}	Gate-Source Voltage-Continuous	±30	V
I_D	Drain Current-Continuous	2.5	A
I_{DM}	Drain Current-Single Plused	10	A
P_D	Total Dissipation @T_C=25℃	63	W
T_j	Max. Operating Junction Temperature	-55~150	℃
T_{stg}	Storage Temperature	-55~150	℃

- **THERMAL CHARACTERISTICS**

SYMBOL	PARAMETER	MAX	UNIT
$R_{th\ j\text{-}c}$	Thermal Resistance, Junction to Case	2	℃/W



DIM	mm MIN	mm MAX
A	19.90	20.10
B	15.75	16.10
C	5.50	5.70
D	0.90	1.10
F	3.30	3.50
G	2.90	3.20
H	5.90	6.10
J	0.595	0.70
K	21.10	22.50
L	1.90	2.25
N	10.80	11.00
Q	4.90	5.10
R	3.75	3.95
S	3.20	3.60
U	9.90	10.10
Y	4.20	4.90
Z	1.90	2.10

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• ELECTRICAL CHARACTERISTICS

T_C=25℃ unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN	MAX	UNIT
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	V_{GS}= 0; I_D= 1mA	1500		V
$V_{GS(th)}$	Gate Threshold Voltage	V_{DS}= V_{GS}; I_D=250uA	3	5	V
$R_{DS(on)}$	Drain-Source On-Resistance	V_{GS}= 10V; I_D= 1.3A		9	Ω
I_{GSS}	Gate-Body Leakage Current	V_{GS}= ±30V;V_{DS}= 0		±100	nA
I_{DSS}	Zero Gate Voltage Drain Current	V_{DS}= 1500V; V_{GS}= 0 V_{DS}= 1500V; V_{GS}= 0;T_j=125℃		10 500	μA
V_{SD}	Diode Forward On-voltage	I_S= 2.5A ;V_{GS}= 0		1.6	V